

μPD72020 CMOS Graphics Display Controller

Description

The μ PD72020 is an enhanced graphics display controller resulting from the implementation of CMOS technology on the μ PD7220A.

In addition to the functions of the μ PD7220A, the μ PD72020 incorporates address space expansion, video RAM control, and write mask functions. It is suitable for a wide range of applications from simple display terminals to high-resolution graphics display devices.

This data sheet covers only functions additional to those of the μ PD7220A. For further details of the μ PD72020, refer to the μ PD72020 User's Manual.

Features

- Enhanced functions compared with the μPD7220A
 - Video memory space: 2M bytes maximum (1M 16-bit words)
 - Control of dual-port RAM (video RAM)
 - Write-masking of any desired bit
 - Enhanced external synchronization function
 - CMOS technology
- □ μPD7220A-compatible functions
 - High-speed graphics drawing: 500 ns/dot (operating at 8 MHz)
 - Selection of drawing timing: flashless/flash mode
 - Drawing of straight lines, arcs, quadrilaterals, graphic characters
 - Any kind of line specifiable
 - Four different dot-correction modes
 - Enlarged drawing/enlarged display
 - Panning and scrolling
 - Automatic cursor shifting
 - Attributes assignable character by character
 - Interlaced/noninterlaced scanning
 - DRAM refreshing
 - Master/slave operation
 - Video memory control independent of main memory
 - 16 x 9-bit on-chip input/output FIFO
 - DMA control
 - Single +5-volt power supply

Applications

Some application functions implemented by use of this product in conjunction with other products may infringe on U.S. Patent No. 4,197,590 and Re. 31,200 etc. held by CADTRAK Corporation of the United States, and the

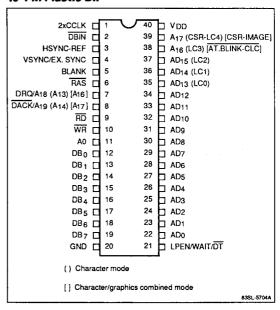
corresponding patents in various countries. Problems may arise from such patents even when a different graphics display controller or discrete circuitry is used, and thus resolution on the basis of this product alone is not possible. Therefore, the user is requested to undertake as his or her own responsibility an investigation of measures to cope with this situation before designing an application system.

Ordering Information

Part No.	Package
μPD72020C-8	40-pin plastic DIP
μPD72020GC-8-3B6	52-pin plastic miniflat

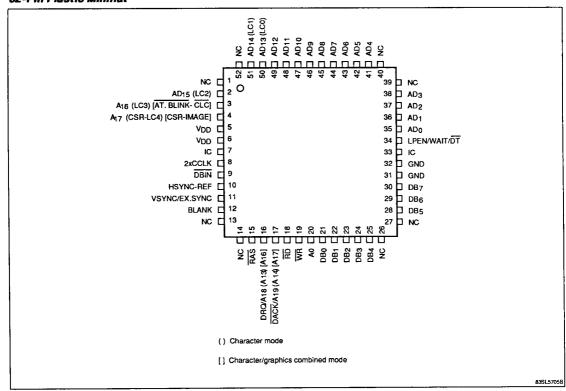
Pin Configurations

40-Pin Plastic DIP





52-Pin Plastic Miniflat



Pin Identification

Symbol	Function
A0	Address select input for microprocessor interface
AD ₀ -AD ₁₂	Address-data lines to display memory
AD ₁₃ /LC0, AD ₁₄ /LC1, AD ₁₅ /LC2	See text and table 3.
A ₁₆ /LC3/AT.BLINK-CLC, A ₁₇ /CSR-LC4/CSR-IMAGE	See text and table 3.
BLANK	CRT blanking output
DACK/A ₁₉ /A ₁₄ /A ₁₇	See text and table 1.
DB ₀ -DB ₇	Bidirectional data bus to host microprocessor
DBIN	Display memory read input flag
DRQ/A ₁₈ /A ₁₃ /A ₁₆	See text and table 1.
HSYNC-REF	Horizontal video sync output

Symbol	Function
LPEN/WAIT/DT	See text and table 2.
RAS	Row address strobe
RD	Read strobe input for microprocessor interface
VSYNC/EX.SYNC	Vertical video sync output or external VSYNC input
WR	Write strobe input for microprocessor interface
2xCCLK	Clock input
GND	Ground
V _{DĐ}	+5-volt power supply
IC	Internal connection
NC.	No connection



PIN FUNCTIONS

Pins on the μ PD7220A and the μ PD72020 have similar functions. Differences are described below.

Pins DRQ and DACK

The functions of these pins depend on the setting of the PN bit by the WMASK command, which validates the address extension functions See table 1.

A₁₃, A₁₄, A₁₆-A₁₉. When the address extension function is selected by setting PN of the WMASK command, the upper 2 bits (of the extended address) are output in the video memory in each display/draw mode.

After the address extension function has been selected, the DMA-related functions cannot be used. Use the CHR and G bits of the SYNC command to set the display/ draw mode (as with the μ PD7220A).

DRQ (DMA Request). When the DMAR or DMAW command is executed, the DMA request signal is output. This signal is input to the DRQ pin of the DMA controller.

After the DMA-related functions have been selected, the address extension functions cannot be used.

DACK (DMA Acknowledge). A signal indicating DMA transfer is input. This signal is output from the DACK pin of the DMA controller.

Pin LPEN/WAIT/DT

The functions of this pin depend on the setting of the DTE bit by the WMASK command, which validates the DT signal generation function. See table 2.

 $\overline{\text{DT}}$ (Data Transfer). When the $\overline{\text{DT}}$ signal generation function is selected by setting DTE of the WMASK command, the $\overline{\text{DT}}$ signal is output to indicate the display address supply timings for the μ PD41264-type video RAMs (VRAMs).

After the DT signal generation function has been selected, the LPEN and WAIT functions cannot be used.

LPEN (Light Pen Strobe). When the light pen detects a light input, the H-level signal is input.

After the LPEN function has been selected, the $\overline{\text{DT}}$ signal generation function cannot be used.

WAIT (Drawing Wait). When a signal that remains at the H-level for a period of at least four clocks is input in the drawing stop mode, the μ PD72020 will stop drawing temporarily if it is executing drawing and output a display address.

After the WAIT function has been selected, the $\overline{\rm DT}$ signal generation function cannot be used.

Pins AD₁₃-AD₁₅, A₁₆, and A₁₇

The functions of some other pins depend on the operating mode: character, graphics, or character/graphics combined. See table 3.

Table 1. Pin Functions Available Through Address Extension

Pin Symbol	PN Bit (WMASK Command)	Action	Mode	I/O	Pin Function
DRQ/A ₁₈ /A ₁₃ /A ₁₆	0	Action similar to μPD7220A		Output	DRQ
	1	Address extension	Graphics	Output	A ₁₈
			Character	Output	A ₁₃
			Combined	Output	A ₁₆
DACK/A ₁₉ /A ₁₄ /A ₁₇	0	Action similar to μPD7220A		Input	DACK
	1	Address extension	Graphics	Output	A ₁₉
			Character	Output	A ₁₄
			Combined	Output	A ₁₇

Table 2. Pin Functions Available Through DT Signal Generation

Pin Symbol	DTE Bit (WMASK Command)	Action	1/0	Pin Function
LPEN/WAIT/ DT	0	Action similar to µPD7220A	Input	LPEN/WAIT
	1	DT signal generation	Output	DΤ



Table 3. Multifunction Pins AD₁₃-AD₁₅, A₁₆, and A₁₇

Pin Symbol	Mode	I/O	Function
AD ₁₃ -AD ₁₅	Graphics; combined	1/0	Address-data lines 13-15 to display memory
LC0-LC2	Character	Output	Line counter bits 0-2
A ₁₆	Graphics	Output	Address bit 16
LC3	Character	Output	Line counter bit 3
AT.BLINK-CLC	Combined	Output	Attribute blink and clear line counter
A ₁₇	Graphics	Output	Address bit 17
CSR-LC4 Character		Output	Cursor and line counter bit 4
CSR-IMAGE	Combined	Output	Cursor and bit-map area flag

ADDED BLOCK FUNCTIONS

Refer to the $\mu PD72020$ Block Diagram and the System Configuration Diagram.

Video RAM Control

Additional blocks generate the \overline{DT} signal, which indicates the display-address supply timings for the video RAMs. Data within the RAMs can be transferred to the serial register.

Pin Extension Control

The video memory address is extended 2 bits (with the address space extended fourfold) in each of the character, character/graphics combined, and graphics modes.

These bits are used for both \overline{DACK} pin and DRQ pin in each mode: A_{14} and A_{13} ; A_{17} and A_{16} ; A_{19} and A_{18} .

WMASK Register

This 16-bit register is used to mask the data for multicolor synchronous drawing with one word in 8/4/2/1-bit configuration.

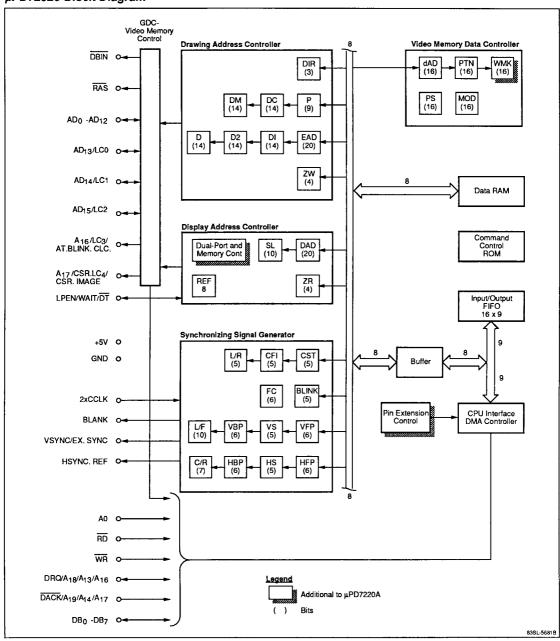
IMPROVED FUNCTIONS

The μ PD72020 functions have been improved while maintaining compatibility with the μ PD7220A in both hardware and software. Table 4 compares functions of the μ PD72020 and the μ PD7220A.

The μ PD72020 is initialized by reset input so that it can function similarly to the μ PD7220A.



μPD72020 Block Diagram





System Configuration Diagram; $\mu PD72020$ With Video RAM Control Signal \overline{DT}

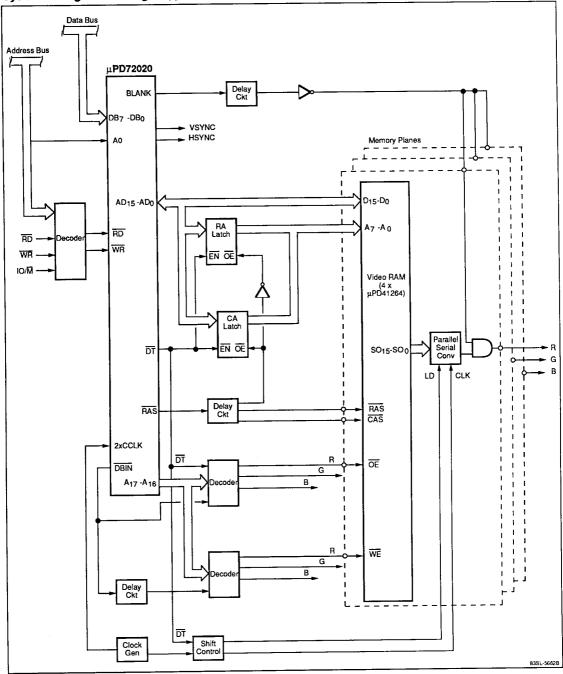




Table 4. Comparison of µPD72020 and µPD7220A Functions

μΡD72020 μΡD7220A

WMASK Command

WMASK command is used to validate the new functions of the µPD72020.

WMASK command is not used.

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0			
CMD	0	1	0	1	1	0	1	0			
P1		WMKL									
P2		WMKH									
P3	PN	TM	DTE	CY1	CY0	0	0	0			

WMK Sets the WMASK register value.

PN Sets the address extension function.

TM Changes the initializing timing of the horizontal synchronization counter in the slave mode for external synchronization, and sets the initializing function of the field

counter.

DTE Sets the function of generating the DT signal.

 $\overline{\text{CY}}$ Set the $\overline{\text{DT}}$ signal output mode and the BLANK signal

mask.

LPEN Command

Light pen address (LAD) is extended 2 bits by setting PN of the WMASK command.

Light pen address (LAD) extension function is not available.

PN 0 Same as μPD7220A

1 EAD is extended 2 bits.

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DBC				
CMD	1	1	0	0	0	0	0	0				
D1		LADL										
D2				LA	DM							
DЗ	X X X X LADH											

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0			
CMD	1	1	0	0	0	0	0	0			
D1		LADL									
D2		LADH									
D3	Х	Х	Х	х	Х	Х	LADH				

CSRW Command

Draw execution address (EAD) is extended 2 bits by setting PN of the WMASK command.

Draw execution address (EAD) extension function is not available.

PN 0 Same as μPD7220A

1 EAD is extended 2 bits.

Character Mode

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
CMD	0	1	0	0	1	0	0	1		
P1				EA	DL					
P2	0	0 EADH								

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0			
CMD	0	1	0	0	1	0	0	1			
P1		EADL									
P2	0	0	0	EADH							



Table 4. Comparison of μPD72020 and μPD7220A Functions (cont)

μPD72020

μPD7220A

CSRW Command (cont)

Character/Graphics Combined Mode (Character Display)

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0				
CMD	0	1	0	0	1	0	0	1				
P1		EADL										
P2		EADM										
P3	0	0	0	0	0	0	EADH					

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
CMD	0	1	0	0	1	0	0	1		
P1		EADL								
P2		EADH								

Character/Graphics Combined Mode (Graphics Display/Drawing)

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
CMD	0	1	0	0	1	0	0	1		
P1		EADL								
P2				EA	DM					
P3		dAD 0 0 EADH								
P4	WG	0	0	0	0	0	0	0		

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
CMD	0	1	0	0	1	0	0	1		
P1		EADL								
P2				EA	DH					
P3		dAD WG 0 0 0								

Graphics Mode

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0			
CMD	0	1	0	0	1	0	0	1			
P1		EADL									
P2				EA	DM						
P3		d/	AD.	-		EA	DH				
P4	WG	vG 0 0 0 0 0 0 0									

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0			
CMD	0	1	0	0	1	0	0	1			
P1		EADL									
P2		EADM									
РЗ		dAD WG 0 EADH									

CSRR Command

Draw execution address (EAD) is extended 2 bits by setting PN of the WMASK command.

Draw execution address (EAD) extension function is not available.

PN 0 Same

Same as µPD7220A

1 EAD is extended 2 bits.

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
CMD	1	1	1	0	0	0	0	0		
D1		EADL								
D2		EADM								
D3	х	Х	х	х		EA	DH			
D4				dA	DL					
D5		dADH								

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0			
CMD	1	1	1	0	0	0	0	0			
D1		EADL									
D2		EADM									
DЗ	х	х	Х	х	х	х	EA	DH			
D4		dADL									
D5		dADH									



Table 4. Comparison of µPD72020 and µPD7220A Functions (cont)

μΡD72020 μΡD7220A

SCROLL Command

Display start address (SAD) is extended 2 bits by setting PN of the WMASK command.

Display start address (SAD) extension function is not available.

PN

0 Same as μPD7220A

1 SAD is extended 2 bits.

Character Mode Built-In RAM Map

	MSB							LSB
RA			С	ontent	s or RA	M		
0				SAI	D1L			
1	0				SAD1F	1	-	
2		SI	_1L		0	0	0	0
3	*	0			SL	1H		
4				SAI	D2L			
5	0				SAD2F	1		
6		SL	SL2L 0 0 0					
7	*	0			ŞL	2H		
8				SAI	D3L			
9	0		•		SAD3H	i		
Α		SL	.3L		0	0	0	0
В	*	0			SL	зн		
С				SAI	D4L			
D	0	SAD4H						
E		SL4L 0 0 0 0						0
F	*	0			SL	4H		•
* DAD)+2							

	MSB							LSB
RA			С	ontent	s or R/	M		
0				SA	D1L			
1	0	0	0			SAD1H	1	
2		SL	1L		0	0	0	0
3	*	0			SL	.1H		
4				SAI	D2L			
5	0	0	0			SAD2H	1	
6		SL	SL2L 0 0 0					0
7	*	0			SL	2H		•
8				SAI	D3L			
9	0	0	0			SAD3H		
Α		ŞL	3L		0	0	0	0
В	*	0			SL	зн		•
С				SAI	D4L	-		
D	0	0 0 SAD4H						
E		SL	SL4L 0 0 0					
F	*	0			SL	4H		
DAC)+2							



Table 4. Comparison of μPD72020 and μPD7220A Functions (cont)

μPD7220A μPD72020

SCROLL Command (cont)

Character/Graphics Combined Mode (Character Display) **Built-In RAM Map**

	MSB							LSB	
RA			С	ontents	of RA	М			
0				SAI	D1L				
1				SAE	1M				
2		SL	.1L		0	0	SAE)1H	
3	*	* 0 SL1H							
4		SAD2L							
5		SAD2M							
6		SL2L 0 0 SAD2H							
7	*	0			SL	2H			
8				SAI	D3L				
9				SAI	D3M				
Α		SI	_3L		0	0	SAI	ОЗН	
В	*	0			SL	зн			
С				SA	D4L				
D		SAD4M							
Е		SL4L 0 0 SAD4H							
F	*	* 0 SL4H							
* DA	D+2	•							

	MSB				-			L\$B		
RA			C	ontents	of RA	М				
0		SAD1L								
1				SAE)1H					
2		SL1L 0 0 0 0								
3	*	* 0 SL1H								
4				SAI	D2L					
5				SAE)2H					
6		SL2L 0 0 0						0		
7	*	0			SL	.2H				
8				SAI	D3L					
9				SAI	озн					
Α		SL	_3L		0	0	0	0		
В	*	0			SL	.3H				
С		SAD4L								
D		SAD4H								
E		SL4L 0 0 0 0								
F	*	0			SI	.4H				
* DAI	D + 2									

* DAD + 2

Character/Graphics Combined Mode (Graphics Display/Drawing) Built-In RAM Map

	MSB							LSE		
RA			С	ontent	s of RA	М				
0		SAD1L								
1				SAI	D1M					
2		SL	.1L		0	0	SAI	D1H		
3	*	IM			SL	.1H				
4				SA	D2L					
5				SAI	D2M					
6		SI	.2L		0	0	SAI	D2H		
7	*	IM SL2H								
* DAI	0+2	1141	L							

+2	* D

	MSB							LSB	
RA			Cor	ntents	of RA	M			
0				SAE)1L				
1				SAE)1H				
2		SL	.1L		0	0	0	0	
3	*	IM			SL1H				
4	<u> </u>			SAE	D2L				
5				SAD	2H				
6		SL	_2L		0	0	0	0	
7	*	IM SL2H							



Table 4. Comparison of µPD72020 and µPD7220A Functions (cont)

μΡD72020 μΡD7220A

Scroll Command (cont)

Graphics Mode Built-In RAM Map

	MSB					LSB		
RA		Contents or RAM						
0			SA	D1L				
1			SAI	D1M				
2		SI	-1L		SAD1H	l		
3	*	IM		SL1F	1			
4		_	SAI	D2L				
5		SAD2M						
6		SI	L2L SAD2H					
7	*	IM	SL2H					

^{*} DAD+2

	MSB					LSB		
RA	•	Contents or RAM						
0			SA	D1L				
1			SAI	D1M				
2		SL1L			0	SAD1H		
3	*	IM		SL	.1H			
4			SAI	D2L				
5			SAI)2M				
6		SL2L 0 0 SAD						
7	* IM SL2H							

^{*} DAD + 2



COMMANDS

The μ PD72020 supports all commands of the μ PD7200A. Although command names are different, opcodes are the same. The μ PD72020 can activate the software created for use with the μ PD7220A.

The improved functions of the μ PD72020 can be used by setting the new WMASK command. Once the RESET command is input, however, the WMASK command becomes inactive and the μ PD72020 maintains the same functions as those of the μ PD7220A.

This section describes the WMASK command as well as the SCROLL, LPEN, CSRW, and CSRR commands, which are affected by the setting of the WMASK command.

WMASK Command

This new command (figure 1) controls four new functions.

- · WMASK register setting
- · Address extension
- Selection of additional functions in the external slave mode
- DT signal generation

Figure 1. WMASK Command Format

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
CMD	0	1	0	1	1	0	1	0		
P1		WMKL								
P2		WMKH								
РЗ	PN	TM	DTE	CY1	CY0	0	0	0		

WMK Bit. The μ PD72020 is equipped with the conventional MASK register and a 16-bit WMASK register. The WMK bit is used to set this WMASK register.

The 16-bit WMASK register is used for write mask of the multicolor, simultaneously-drawn data with one word set in 8-, 4-, 2- and 1-bit formats. Each bit of the WMASK register corresponds to each bit of the drawn data.

- (1) When a WMASK register bit is set to 0 by the WMK, the drawn data bit corresponding to the WMASK register bit set to 0 is not affected by drawing.
- (2) When a WMASK register bit is set to 1 by the WMK, operation is similar to the μPD7220A. Thus, the

drawn data bit corresponding to the WMASK register bit set to 1 is affected by drawing.

When the RESET command is input, the μ PD72020 is set to this mode.

PN Bit. PN is used to set the address extension function for the video memory.

(1) When PN = 0, operation is similar to the μ PD7220A. Thus, the address extension function cannot be used.

When the RESET command is input, the μ PD72020 is set to this mode.

(2) When PN = 1, the video memory address is extended 2 bits (with the address space expanded fourfold).

The DRQ/A $_{18}$ /A $_{13}$ /A $_{16}$ pin and the \overline{DACK} /A $_{19}$ /A $_{14}$ /A $_{17}$ pin output the upper 2 bits of the extended address. The DMA-related functions cannot be used.

The address to be output depends on the display and drawing modes. See table 1. The address space is shown in table 5.

Table 5. Address Space With Extended Address

	Character	Character/Graphics	Graphics	
	Mode	Combined Mode	Mode	
Address	15 bits	18 bits	20 bits	
	(32K words)	(256K words)	(1M words)	

As the address space is expanded, the following command bits are also extended.

- · LAD bit of LPEN command
- · EAD bit of CSRW command
- EAD bit of CSRR command
- SAD bit of SCROLL command

Refer to the description of each command for details.

TM Bit. TM has been added to solve the following two problems with the μ PD7220A.

 Because the vertical and horizontal counters are initialized at the start of VFP and HFP, respectively, when the external synchronizing signal is input to the μPD7220A, horizontal positioning cannot be readily done for synchronization with the μPD7220A by inputting a synchronizing signal from the external device.



 When the μPD7220A is operated in the interlace mode, input of the external synchronizing signal causes no effect on the field counter. Thus, if the synchronizing signal is unconditionally input from the external device when the μPD7220A is in the second field, the second and first fields are reversed in subsequent frames and the fields do not conform with the external device.

When the μ PD72020 operates in the slave mode for external synchronization, the setting of the TM bit will cause the μ PD72020 to operate differently from the μ PD7220A in the following operations.

- The timing of initializing the horizontal synchronous counter is changed.
- The initializing function of the field counter is validated.

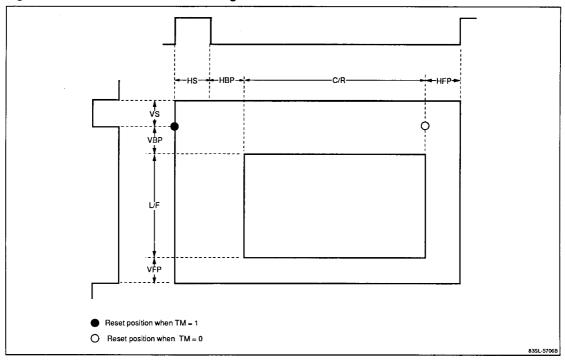
When TM = 0, the function similar to the external synchronizing function of the μ PD7220A is carried out. When the RESET command is input, the μ PD72020 is set to this mode.

When TM = 1, the following two operations differ from those of the μ PD7220A.

- (1) When the RESET command is executed or the EX.SYNC (external synchronizing signal) is input, the horizontal counter is reset at the rising edge of the HS. See figure 2.
- (2) When the RESET command is executed in the interlace mode or the EX.SYNC signal is input, the field counter is unconditionally reset to the first field mode.

Thus, the VSYNC signal in the second field should be removed externally so that the synchronizing signal applied to the EX.SYNC pin serves as the VSYNC signal in the first field (in the interlace mode).

Figure 2. Horizontal Counter Reset Timing





DTE, CY1, CY0 Bits. To prevent the display screen from becoming blurred during drawing operations, the μ PD7220A normally performed drawing in the flashless drawing mode. Thus, the drawing period was limited and it was difficult to improve the drawing efficiency.

To solve this problem, video RAMs can be used for the μ PD72020. Through the use of VRAMs, both drawing and display can be carried out simultaneously in the flashless drawing mode with the result that the drawing efficiency can be improved. DTE, CY1, and CY0 are used to control the μ PD41264-type VRAMs and the BLANK signal.

Table 6. DT Signal Output Modes

DTE	CY1	CY0	Function
0	0	0	GDC mode 0
0	0	1	GDC mode 1 (BLANK signal mask †)
0	1	0	Inhibited
0	1	1	Inhibited
1	0	0	DT signal output mode 0 (BLANK signal mask †)
1	0	1	Inhibited
1	1	0	DT signal output mode 1 (BLANK signal mask †)
1	1	1	DT signal output mode 2 (BLANK signal mask †)

† If the µPD72020 has started drawing operations in the display mode, the BLANK signal is not set to H.

DTE = **0.** Operation is similar to the μ PD7220A. The $\overline{\text{DT}}$ signal functions cannot be used. The LPEN/WAIT/ $\overline{\text{DT}}$ pin performs the LPEN or WAIT functions.

The following two modes are available by setting CY1 or CY0 (table 6).

- (1) GDC mode 0 operation is similar to the μ PD7220A. When the RESET command is input, the μ PD72020 is set to this mode.
- (2) GDC mode 1 operation is similar to GDC mode 0 except if the μPD72020 starts drawing operations during the display period, the BLANK signal is not set to H even in the flash screen mode.

 $\overline{\text{DT}}$ = 1. The $\overline{\text{DT}}$ signal functions are enabled and the $\overline{\text{DT}}$ signal is output from the LPEN/WAIT/ $\overline{\text{DT}}$ pin. The $\overline{\text{DT}}$ signal is used for display timing when the display memory consists of dual-port video RAMs. The VRAMs allow drawing during both drawing and display cycles.

When DTE is set to 1, the μ PD72020 internally tracks the display address and outputs it and the \overline{DT} signal under either of two conditions.

- (1) At the start of every horizontal scan line (figure 3).
- (2) When the lower 8 bits of the display address (DAD) internal counter are 0.

The starting display address should be set before setting DTE to 1. The μ PD72020 will temporarily stop a drawing operation before issuance of the \overline{DT} signal, as in the case of the μ PD7220A WAIT function.

The \overline{DT} signal output timing depends on the setting of the IM and DAD+2 bits of the SCROLL command. CY0 and CY1 determine which of the following three \overline{DT} signal output modes is used.



Mode 0 With DTE = 1. In mode 0, the \overline{DT} signal is output as shown in figure 4.

- (1) At the start of every horizontal scan line.
- (2) When the lower 8 bits of the DAD counter change from FEH or FFH to 00H.

Additionally, the \overline{DT} signal active state in mode 0 has the following qualifications.

- (1) DT may become active in succession; for example, when the DAD counter changes to 00H just after the start of a horizontal scan line as in figure 4C.
- (2) When the lower 8 bits of the DAD counter become 00H in succession, DT becomes active during the first cycle only. See figure 4D.
- (3) DT will not become active during HFP, HS, HBP, VFP, VS, or VBP periods.

Mode 1 With DTE = 1. In mode 1, the \overline{DT} signal is outut as shown in figure 5A.

(1) At the start of every horizontal scan line.

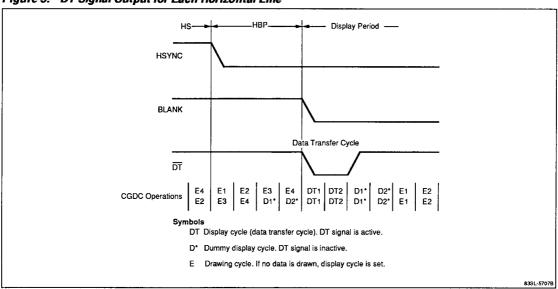
(2) When the lower 8 bits of the DAD counter change from FEH or FFH to 00H.

Additionally, the \overline{DT} signal active state in mode 1 has the following qualifications.

- (1) DT may become active in succession.
- (2) When the lower 8 bits of the DAD counter change to 00H in succession, DT is active only during the first cycle.
- (3) DT can become active during HFP, HS, HBP, VFP, VS, or VBP periods.
- (4) \overline{DT} will not become active while the DMA refresh operation is disabled (D-bit of SYNC command set to 1).
- (5) DT becomes active every four cycles.

Mode 2 With DTE = 1. In mode 2, the \overline{DT} signal output is the same as described for mode 1 except \overline{DT} is active every eight cycles instead of every four cycles. See figure 5B.

Figure 3. DT Signal Output for Each Horizontal Line







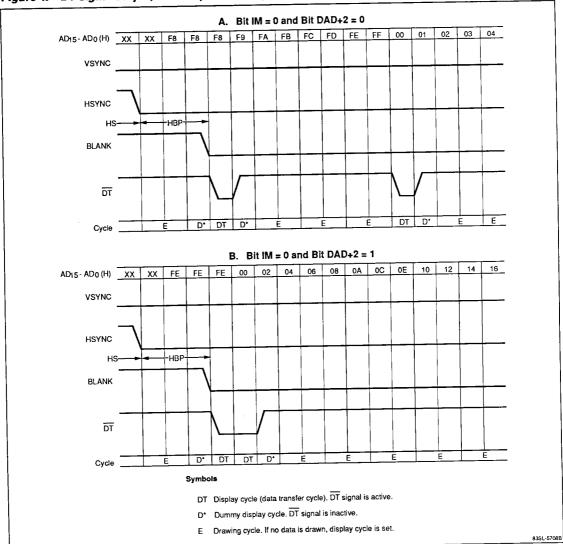
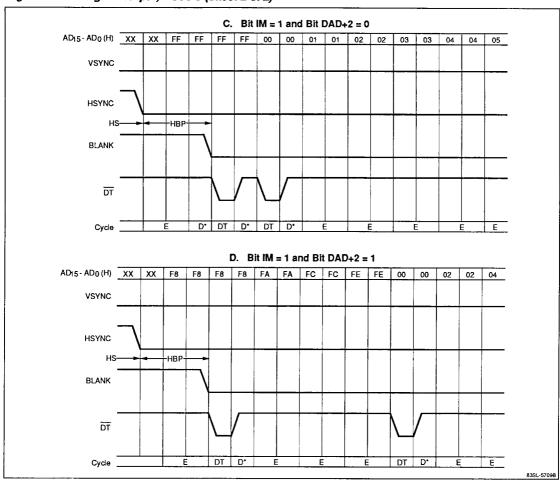
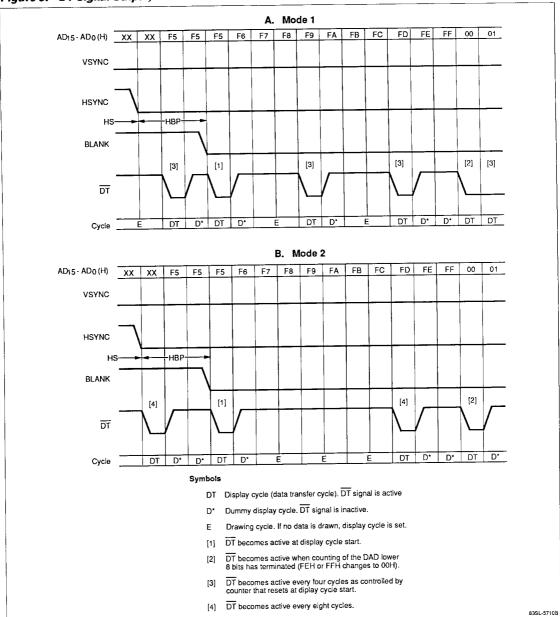




Figure 4. DT Signal Output, Mode 0 (Sheet 2 of 2)









LPEN Command

When the address extension function is set by the WMASK command (with PN set to 1), the upper 2 bits of the light pen address (LAD) in the LPEN command are extended and a maximum of 20 bits can be used.

When PN = 0, the light pen address (LAD) is the same as with the μ PD7220A.

The LPEN command format with the extended LAD is shown in figure 6.

Figure 6. LPEN Command Format

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
CMD	1	1	0	0	0	0	0	0		
D1		LADL								
D2		LADM								
D3	Х	Х	Х	Х		LA	DH			

CSRW Command

When the address extension function is set by the WMASK command (with PN set to 1), the upper 2 bits of the drawing execution address (EAD) in the LPEN command are extended.

When PN = 0, the drawing execution address (EAD) is the same as with the μ PD7220A.

Address extension causes the WG bits to be positioned differently in the character/graphics combined mode (character display/drawing) or the graphics mode.

The CSRW command formats are included in table 4.

CSRR Command

When the address extension function is set by the WMASK command (with PN set to 1), the upper 2 bits of the drawing execution address (EAD) in the LPEN command are extended and a maximum of 20 bits can be used.

When PN = 0, the drawing execution address (EAD) is the same as with the μ PD7220A.

The CSRR command format with the extended EAD is shown in figure 7.

Figure 7. CSRR Command Format

_									
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
CMD	1	1	1	0	0	0	0	0	
D1		EADL							
D2		EADM							
D3	х	Х	х	Х		EADH			
D4		dADL							
D5	dADH								

SCROLL Command

When the address extension function is set by the WMASK command (with PN set to 1), the upper 2 bits of the display start address (SAD) in the SCROLL command are extended.

When PN = 0, the display start address (SAD) is the same as with the μ PD7220A.

The SCROLL command format is shown in figure 8. The built-in RAM map with the extended SAD is included in table 4.

Figure 8. SCROLL Command Format

	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
CMD	0	1	1	1		R	A	



Absolute Maximum Ratings

 $T_A = +25^{\circ}C$

^	
Supply voltage, V _{DD}	- 0.5 to +7.0 V
Input voltage, V _I	- 0.5 to V _{DD} + 0.3 V
Output voltage, V _O	- 0.5 to V _{DD} + 0.3 V
Operating temperature, TOPT	− 10 to +70°C
Storage temperature, T _{STG}	- 65 to +150°C

Exposure to Absolute Maximum Ratings for extended periods may affect device reliability; exceeding the ratings could cause permanent damage.

DC Characteristics

 $T_A = -10 \text{ to } +70^{\circ}\text{C}; V_{DD} = +5.0 \text{ V} \pm 10\%$

Parameter	Symbol	Min	Max	Unit	Conditions
Low-level input	V _{IL}	- 0.5	0.8	٧	Except 2xCCLK
voltage		-0.5	0.6	٧	2xCCLK
High-level input voltage	V _{IH}	2.2	V _{CC} + 0.5	٧	Except 2xCCLK, WR
		3.5	V _{CC} + 0.5	٧	2xCCLK
		2.5	V _{CC} + 0.5	٧	WR
Low-level output voltage	V _{OL}		0.45	V	$I_{OL} = 2.2 \text{ mA}$
High-level output voltage	V _{OH}	0.7 V _{DD}		٧	1 _{OH} = -400 μA
Low-level input leakage current	ILIL		-10	μА	V _I = 0 V; except VSYNC, DACK
			-500	μΑ	V _I = 0 V; VSYNC, DACK
High-level input leakage current	l _{LIH}		10	μА	V _I = V _{DD} ; except LPEN/WAIT/ DT
			500	μΑ	V _I = V _{DD} ; LPEN/WAIT/DT
Low-level output leakage current	I _{LOL}		-10	μΑ	V _O = 0 V
High-level output leakage current	lLOH		10	μΑ	$V_{O} = V_{DD}$
Supply current	lcc		70	mA	

Capacitance

 $T_A = +25$ °C; $V_{DD} = GND = 0 V$

Item	Symbol	Min	Max	Unit	Condition
Input	Cl		15	pF	f = 1 MHz;
Output	Со		20	рF	0 V except for tested pin
Input/output	C _{1/O}		20	рF	
Clock input	C _C		20	рF	-

AC Characteristics

 $T_A = -10 \text{ to } +70^{\circ}\text{C}; V_{DD} = +5.0 \text{ V} \pm 10\%$

tem	Symbol	Min	Max	Unit	Conditions
Clock 2xCCLK					
Clock cycle	t _{CY}	125	10,000	ns	
High-level clock width	tсн	52		ns	
Low-level clock width	[†] CL	52		ns	
Clock rise time	t _{CR}		15	ns	
Clock fall time	t _{CF}		15	ns	
Read Cycle					
Address setup time to RD ↓	t _{AR}	0		ns	
Address hold time from RD ↑	^t RA	0		ns	
RD pulse width	t _{RR1}	^t RD1 +20		ns	
Data output delay time from RD ↓	t _{RD1}		55	ns	C _L = 50 pF
Data float delay time from RD ↑	t _{DF}	0	55	ns	
RD pulse cycle	tRCY	4.5 t _{CY}		ns	DE = 0
		12 t _{CY}		ns	DE = 1
RD recovery time	t _{RV}	2 t _{CY}		ns	Also valid in DMA cycle
Write Cycle					
Address setup time to WR ↓	t _{AW}	0		ns	
Address hold time from WR ↑	t _{WA}	10		ns	
WR pulse width	t _{WW}	60		ns	
Data setup time to WR ↑	^t DW	45		ns	
Data hold time from ₩R ↑	t _{WD}	10		ns	- -
WR pulse cycle	twcy	4.5 t _{CY}		ns	
WR recovery time	t _{RV}	2 t _{CY}		ns	Also valid in DMA cycle
DMA Read Cycle	,				
DACK setup time to RD ↓	t _{AKR}	0		ns	
DACK hold time from RD ↑	^t RAK	0		ns	
RD pulse width	t _{RR2}	[†] RD2 + 20		ns	
Data output delay time from RD ↓	t _{RD2}		2 t _{CY} +60	ns	C _L = 50 pF



AC Characteristics (cont) $T_A = -10 \text{ to } +70^{\circ}\text{C}; V_{DD} = +5.0 \text{ V} \pm 10\%$

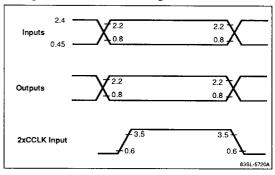
$T_A = -10 \text{ to } +70^{\circ}\text{C}; V_{DD} = +5.0 \text{ V} \pm 10\%$							
Item	Symbol	Min	Max	Unit	Conditions		
DMA Read Cycle(cont)							
DREQ output delay time from 2xCCLK ↑	t _{CRQ}		75	ns	C _L = 50 pF		
DREQ setup time to DACK ↓	t _{RQAK}	0		ns			
DREQ ↓ delay time from DACK ↓	t _{AKRQ}		1.5 t _{CY} + 80	ns	C _L = 50 pF		
DACK pulse cycle	†AKCY	4.5 t _{CY}		ns	See Note.		
High-level DACK width	^t AKH	[‡] CY		ns			
Low-level DACK width	t _{AKL}	2.5 t _{CY}		ns			
DMA Write Cycle)						
DACK setup time to WR ↓	takw	0		ns			
DACK hold time from WR ↑	twak	0		ns			
Read/Modify/Wri	Read/Modify/Write Cycle						
Address/data delay time from 2xCCLK ↑	^t CA	15	80	ns	C _L = 50 pF		
Address/data float delay time from 2xCCLK ↑	[†] CAF	15	80	ns	C _L = 50 pF		
Data setup time to 2xCCLK ↓	†DC	0		ns			
Data hold time from 2xCCLK ↓	^t CDF	[†] CBI		ns			
DBIN delay time from 2xCCLK ↓	^t CBI	15	60	ns	C _L = 50 pF		
RAS ↑ delay time from 2xCCLK	^t CRSH	15	60	ns	C _L = 50 pF		
RAS ↑ delay time from 2xCCLK ↓	^t CRSL	15	50	ns	$C_L = 50 pF$		
High-level RAS width	^t RSH	1/3 ^t CY		ns			
Low-level RAS width	t _{RSL}	1.5 t _{CY} - 30		ns			
Address setup time to ARSL ↓	^t ARSL	30		ns			
Display Cycle							
Output signal delay time from 2xCCLK ↑	tco		70	ns	C _L = 50 pF		

AC Characteristics (cont) $T_A = -10 \text{ to } +70^{\circ}\text{C}; V_{DD} = +5.0 \text{ V} \pm 10\%$

Item	Symbol	Min	Max	Unit	Conditions
Input Cycle					
Input signal setup time to 2xCCLK ↑	t _{PC}	10		ns	
Input signal pulse width	tpp	t _{CY}		ns	

Note: Performs two-dimensional rectangular area assignment whereby the dc parameter is set to other than 0. When byteby-byte transfer is specified, the value is 5.5 t_{CY}.

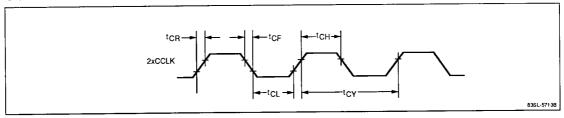
Voltage Thresholds for Timing Measurements



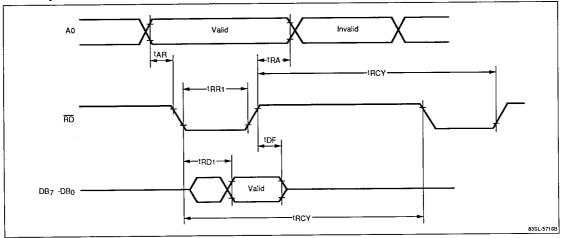


Timing Waveforms

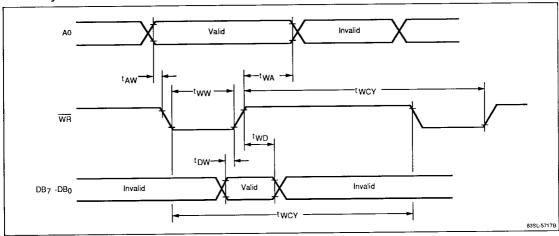
Clock 2xCCLK



Read Cycle



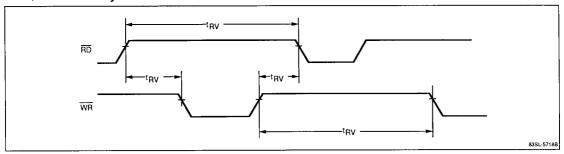
Write Cycle



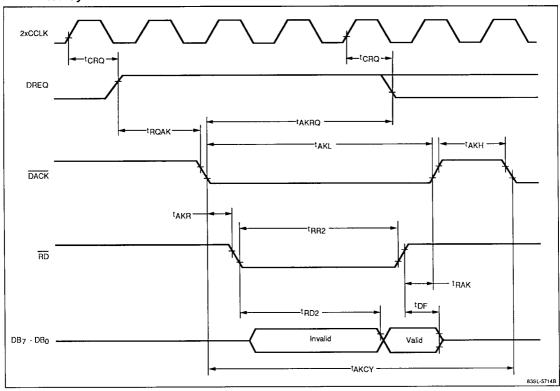


Timing Waveforms (cont)

Read/Write Recovery



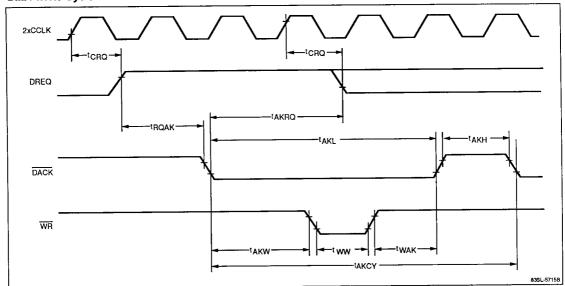
DMA Read Cycle



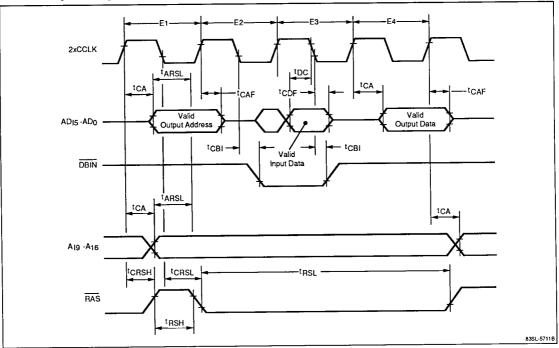


Timing Waveforms (cont)

DMA Write Cycle



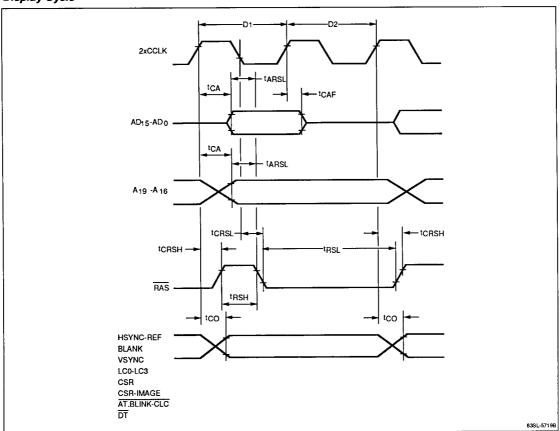
Read/Modify/Write Cycle





Timing Waveforms (cont)

Display Cycle



Input Cycle

